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Synthesis and characterization of novel highly soluble and optical transparent polyimides containing *tert*-butyl and morpholinyl moieties

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Abstract A series of novel organo-soluble and optical transparent polyimides were synthesized via conventional one-step polycondensation from a novel diamine, 3,3'-diterbutyl-4,4'diaminodiphenyl-4"-morpholinophenylmethane (TAMPM) and various commercial aromatic dianhydrides. The structures of monomer and polymers were confirmed by FT-IR and NMR. The solubility, thermal stability, optical transparency, dielectric and hydrophobic properties of polyimides were investigated. The results showed polymers presented excellent solubility in common organic solvents, such as N,Ndimethylformamide (DMF), N.N-dimethyl acetamide (DMAc), dimethyl sulfoxide (DMSO), N-methyl-2-pyrrolidone (NMP), chloroform (CHCl₃), tetrahydrofuran (THF) and dichloromethane (CH₂Cl₂). The polymers exhibited prominent thermal stability and high optical transparency with the glass transition temperature (T_{g}) in the range of 311– 355 °C, and the cutoff wavelengths in the range of 287-344 nm. Furthermore, all of the polymers also presented low dielectric constants in the range of 2.85-3.16 at 1 MHz, and outstanding hydrophobic properties with the contact angle in the rang of 85.1–94.2 °.

Xiaohua Huang huangxiaohua@glut.edu.cn **Keywords** Polyimides · Thermal stability · Solubility · Transparency · Dielectric constant

Abbreviations

TAMPM	3,3'-diterbutyl-4,4'-diaminodiphenyl-4"-
	morpholinophenylmethane
PMDA	Pyromellitic dianhydride
BPDA	3,3',4,4'-biphenyltetracarboxylic dianhydride
ODPA	4,4'-oxydiphthalic anhydride
BTDA	3,3,4,4'-benzophenone tetracarboxylic
	dianhydride
6FDA	(4,4-hexafluoroisopropylidene)-diphthalic
	anhydride

Introduction

It is well known that polyimides are a class of representative high-performance polymers because of its excellent integrative properties, such as high thermal stability, excellent mechanical properties, good dimensional stability, remarkable insulation performance and prominent hydrophobic properties, and so on. At present, they are extensively used in various fields of microelectronics, optoelectronics, aerospace, automobile, gas separation, polymer electrolyte fuel cells, polymer memories, etc. [1–5]. However, polyimides often present poor solubility in common solvents and have high melting temperature. It is due to aromatic polyimide have rigid chains and strong interchain interaction. Strong interactions of polymer derive from intra- and interchain charge transfer complex (CTC) formation and electronic polarization, which lead to deep color of polyimides.

In order to overcome these drawbacks of polyimides as mentioned above, there are many efforts to develop

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solubility and processability of polyimides by modifying the molecular structure of the chain backbones. So far, the major structural modification method has been involved by the introduction of flexible linkages, such as -O-, -S-, -CH₂- and -SO₂- [6-8], bulky substituents [9-12], bulky pendant group [13-15], non-coplanar [16, 17], unsymmetrical structure, such as ortho- or metalinked unit [18-20], and acyclic moieties into the polymer backbones [21-23]. The solubility and optical transparency of polyimides could be improved by introduction of flexible ether and acyclic linkages in the polymer backbone. Unfortunately, it will sacrifice some of their advantageous properties by the modification method, such as thermal stability and mechanical property. It must be emphasized that much efforts have been devoted to synthesizing fluorinated polyimide by incorporation of fluorinated substituent, especially the trifluoromethyl group [24–28]. The optical transparency and solubility of fluorinated polyimide has been significantly improved, which resulted from low polarizability of the bond and the increase in free volume. Its application, however, is subject to some limit due to high-cost of the fluoride monomer in many fields. Therefore, it is well recognized the incorporation of bulky substituents, non-coplanar and unsymmetrical structures into main chain may have improved the solubility and processability of polyimide, and not sacrificing their thermal stability and mechanical properties. Such structure type of polyimides can decrease the rigidity of the polymer backbone and loosen close packing of the chains, which reduce the interchain interactions, and then improve the solubility and processability of polyimides.

In comparison with the previous research work, we expect to provide a new approach to design and synthesize a series of novel organo-soluble and transparent polyimides without sacrificing their thermal stability and mechanical properties. In this paper, a series of novel polyimides are prepared by incorporation of the larger bulky groups (tert-butyl) and non-planar steric structures (morpholinyl moieties) in the polymer chain, and utilizing the synergism of tert-butyl and morpholinyl moieties to obtain a series of organosoluble and transparent polyimides. A novel diamine monomer 3,3'-diterbutyl-4,4'-diaminodiphenyl-4"morpholinophenylmethane (TAMPM) was designed and synthesized firstly, and then used to obtain a series of polyimides bearing tert-butyl and morpholinyl moieties by one-step polycondensation with various aromatic dianhydrides. All of obtained polymers were characterized and their physical properties, such as solubility behavior, thermal stability, optical transparency, dielectric constant and hydrophobic properties were summarized.

Experimental

Materials

2-*tert*-butylaniline (Wuxi TPW Pharmaceutical Technology Co. Ltd.) and 4-morpholinobenzaldenhyde (Accela ChemBio Co. Ltd.), Pyromellitic dianhydride (PMDA) (Shanghai Guoyao Chemical Co. Ltd.), 3,3',4,4'-biphenyltetracarboxylic dianhydride (BPDA), 4,4'-oxydiphthalic anhydride (ODPA) (Changzhou Linchuan Chemical Co. Ltd.), 3,3,4,4'-benzophenone tetracarboxylic dianhydride (BTDA) and (4,4hexafluoroisopropylidene)-diphthalic anhydride (6FDA) (Tokyo Chemical Industry Co. Ltd.) were recrystallized from acetic anhydride and then dried in vacuums at 120 °C overnight before use. *N*, *N*-dimethyl formamide (DMF) and m-Cresol (Shanghai Guoyao Chemical Co. Ltd.) were purified by vacuum distillation over calcium hydride prior to use. All the other solvents were analytical-grade and used without further purification.

Monomer synthesis

3,3'-diterbutyl-4,4'-diaminodiphenyl-4"morpholinophenylmethane (TAMPM)

In a 100 mL three-necked round-bottomed flask equipped with a condenser, dropping funnel and nitrogen inlet, 4morpholinobenzaldenhyde (12.0 g, 0.063 mol) and 2-tertbutylaniline (23.41 g, 0.16 mol) was added and heated 120 °C under nitrogen atmosphere. 2.5 mL hydrochloric acid (12 N) was dropped in the mixture of 4morpholinobenzaldenhyde and 2-tert-butylaniline about 1 h, then the mixture was heated 150 °C about 10 h under nitrogen atmosphere. When the reaction was completed, the reaction mixture was cooled to 60 °C, and 10 % aqueous solution of NaOH (12.0 mL) was added to the mixture. After fully neutralized, the mixture was poured into separating funnel and extracted by 100 mL CH₂Cl₂, then washed by appropriate water three times until PH was about 7. The obtained mixture solution was dried over anhydrous MgSO₄, filtered and CH₂Cl₂ evaporated to obtain brown powder, then the monomer compound was purified by column chromatography on silica gel [V(ethyl acetate) : V(hexane)=2:5] to give white solid production (19.32 g, 65 % yield); m.p. 155.2 °C (by DSC at a scan rate of 5 °C/min)

¹H NMR (400 MHz, DMSO) δ : 6.91 (d, 2H, *J*= 8.0 Hz), δ : 6.86 (s, 2H), δ : 6.81 (d, 2H, *J*=8.8 Hz), δ : 6.59 (d, 2H, *J*=7.6 Hz), δ : 6.52 (d, 2H, *J*=8.0 Hz), δ : 5.04 (s, 1H), δ : 4.56 (s, 4H -NH₂), δ : 3.68 (t, 4H, *J*=4.8 Hz), δ : 3.00 (t, 4H *J*=4.8 Hz), δ : 1.23 (s, 18H, -CH₃); ¹³C NMR (400 MHz, DMSO) δ : 149.29, 144.09, 137.37, 133.20, 131.98, 129.70, 127.30, 126.99, 117.22, 115.23, 66.60, 54.99, 49.14, 34.41, 29.73. FT-IR (KBr, cm⁻¹): $3500 \sim 3300 \text{ cm}^{-1}$ (-NH₂), $3000 \sim 2800 \text{ cm}^{-1}$ (C-H), 1120 cm^{-1} (C-O-C); MS (m/z): 472.3 ([M+H]⁺).

Polymer synthesis

The general procedure for the preparation of the polyimides was given in Scheme 2. All polyimides were prepared by onestep procedure. The mixture of TAMPM (0.8873 g, 1.88 mmol) and BPDA (0.5535 g, 1.88 mmol), 15.0 mL m-Cresol and 5 drops of isoquinoline were added to in 50 mL three-necked round-bottomed flask equipped with a mechanical stirrer, nitrogen inlet and a reflux condenser. The mixture was stirred at room temperature for 1 h in nitrogen atmosphere, and then heated to 50 °C until the solid completely dissolved. Then the reaction was heated to 120 °C for 4 h, and for another 12 h at 200 °C. After the reaction was cooled, the viscosity mixture solution was slowly poured into 400 mL alcohol to obtain fibrous precipitate. The precipitate was filtered, and washed with alcohol several times, and then dried for 12 h by vacuum drying oven in 120 °C. At last the polymer PI-2 (TAMPM-BPDA) was obtained by re-precipitating at least twice. The PI-1 (TAMPM -PMDA), PI-3 (TAMPM -ODPA), PI-4 (TAMPM -BTDA) and PI-5 (TAMPM -6FDA) were also prepared according to a similar method as mentioned above.

PI-1

The PI-1 was prepared from diamine (TAMPM) and PMDA. The yield was 94 %. ¹H NMR (400 MHz, DMSO) δ : 8.44 (d, 2H, ArH), δ : 7.42 (d, 2H, ArH), δ : 7.36 (s, 2H, ArH), δ : 7.16 (d, 2H, ArH), δ : 7.11 (d, 2H, ArH), δ : 6.95 (s, 2H, ArH), δ : 5.70 (s, H, CH), δ : 3.70 (s, 4H, CH₂), δ : 3.07 (s, 4H, CH₂), δ : 1.17 (s, 18H, CH₃). FT-IR (KBr, cm⁻¹): 3031~2872 (alkyl), 1779 and 1731 (C=O, imide, stretching vibration), 1374 (C-N), 732 (C=O, imide, bending vibration). Elemental analysis calculated for (C₄₁H₄₃N₃O₇)_n: C, 71.39 %; N, 6.09 %. Found: C, 71.16 %; N, 6.12 %.

PI-2

The PI-2 was prepared from diamine (TAMPM) and BPDA. The yield was 92 %. ¹H NMR (400 MHz, DMSO) δ : 8.44 (s, 2H, ArH), δ : 8.36 (d, 2H, ArH), δ : 8.09 (d, 2H, ArH), δ : 7.42 (d, 2H, ArH), δ : 7.28 (d, 2H, ArH), δ : 7.11 (d, 2H, ArH), δ : 7.00 (d, 2H, ArH), δ : 6.94 (d, 2H, ArH), δ : 7.68 (s, H, CH), δ : 3.70 (m, 4H, CH₂), δ : 3.06 (m, 4H, CH₂), δ : 1.17 (s, 18H, CH₃). FT-IR (KBr, cm⁻¹): 3031~2870 (alkyl), 1777 and 1727 (C=O, imide, stretching vibration), 1371 (C-N), 746 (C=O, imide, bending vibration). Elemental analysis calculated for (C₄₇H₄₃N₃O₅)_n: C, 77.34 %; N, 5.76 %. Found: C, 78.29 %; N, 5.68 %.

PI-3

The PI-3 was prepared from diamine (TAMPM) and ODPA. The yield was 90 %. ¹H NMR (400 MHz, DMSO) δ : 8.04 (d, 2H, ArH), δ : 7.66 (d, 2H, ArH), δ : 7.63 (d, 2H), δ : 7.39 (d, 2H, ArH), δ : 7.22 (s, 2H, ArH), δ : 7.08 (m, 4H, ArH), δ : 6.92 (d, 2H, ArH), δ : 5.65 (s, H, CH), δ : 3.69 (m, 4H, CH₂), δ : 3.05 (m, 4H, CH₂), δ : 1.14 (s, 18H, CH₃). FT-IR (KBr, cm⁻¹): 3031 ~2871 (alkyl), 1779 and 1726 (C=O, imide, stretching vibration), 1374 (C-N), 750 (C=O, imide, bending vibration). Elemental analysis calculated for (C₄₇H₄₃N₃O₆)_n: C,75.68 %; N, 5.63 %. Found: C, 76.43 %; N, 5.58 %.

PI-4

The PI-4 was prepared from diamine (TAMPM) and BTDA. The yield was 95 %. ¹H NMR (400 MHz, DMSO) δ : 8.25 (d, 2H, ArH), δ : 8.20 (d, 2H, ArH), δ : 7.93 (d, 2H, ArH), δ : 7.63 (d, 2H, ArH), δ : 7.40 (d, 2H, ArH), δ : 7.29 (d, 2H, ArH), δ : 7.08 (d, 2H, ArH), δ : 6.92 (d, 2H, ArH), δ : 5.67 (s, H, CH), δ : 3.69 (m, 4H, CH₂), δ : 3.05 (m, 4H, CH₂) δ : 1.15 (s, 18H, CH₃). FT-IR (KBr, cm⁻¹): 3031~2870 (alkyl), 1779 and 1727 (C=O, imide, stretching vibration), 1374 (C-N), 727 (C=O, imide, bending vibration). Elemental analysis calculated for (C₄₈H₄₃N₃O₆)_n: C, 76.07 %; N, 5.54 %. Found: C, 75.88 %; N, 5.61 %.

PI-5

The PI-5 was prepared from diamine (TAMPM) and 6FDA. The yield was 91 %. ¹H NMR (400 MHz, DMSO) δ : 8.13 (d, 2H, ArH), δ : 7.93 (d, 2H, ArH), δ : 7.83 (d, 2H, ArH), δ : 7.37 (d, 2H, ArH), δ : 7.29 (d, 2H, ArH), δ : 7.07 (m, 4H, ArH), δ : 6.91 (d, 2H, ArH), δ : 5.64 (s, H, CH), δ : 3.68 (m, 4H, CH₂), δ : 3.04 (m, 4H, CH₂), δ : 1.13 (s, 18H, CH₃). FT-IR (KBr, cm⁻¹): 3032~2871 (alkyl), 1786 and 1728 (C=O, imide, stretching vibration), 1372 (C-N), 724 (C=O, imide, bending vibration). Elemental analysis calculated for (C₅₀H₄₃F₆N₃O₅)_n: C, 68.65 %; N, 4.78 %. Found: C, 69.46 %; N, 4.70 %.

Preparation of membranes

The transparent and flexible polyimide films were obtained by the method of solution casting. The polyimide was dissolved



Scheme 1 Synthesis of diamine TAMPM



in DMF with a concentration of approach 2 wt.% or 10 wt.%. Then the solution of polymer was poured into dry-clean glass plate and solvent DMF was disappeared at 60 °C for 24 h. When the most of the DMF was evaporated, the polymer film was formed and then was heated at 180 °C in vacuum drying oven for 12 h to evaporate the residual DMF completely. Then the polyimide films was cooled to room temperature, moved to water, peeled off from the glass substrate, and removed water in a vacuum drying oven for 120 °C for 12 h.

Characterization

NMR spectrum was recorded using an Avance III 400 instrument with deuterated dimethylsulfoxide (DMSO- d_6) as solvent and tetramethylsilane (TMS) as an internal standard. Fourier transform infrared (FT-IR) spectrum was studied on a Thermo Nexus 470 FTIR spectrometer. UV-visible spectrum (UV–vis) was performed on a UV-3600 UV-visible spectrophotometer. Thermogravimetric analysis (TGA) was carried out on a TGA Q500 analyzer at a heating rate of 10 °C·min⁻¹ in nitrogen. Differential scanning calorimetry (DSC) was evaluated on a DSC-204 phoenix thermal analyzer instrument at a heating rate of 20 °C·min⁻¹ in a nitrogen atmosphere.

Scheme 2 Synthesis of polyimides

Elemental analysis was investigated by a Perkin-Elmer model 2400 II instrument. Mass spectrometry was performed an Elementar Vario EL III/Isoprime. Gel permeation chromatography (GPC) was measured on a Waters 1515 analyzer relative to polystyrene standard using DMF as the eluent. Dielectric constant was determined by the parallel plate capacitor method using a dielectric analyzer (Agilent 4294A) on thin film. Gold electrode was vacuum deposited coating on both surfaces of film, and these films were tested in a dry chamber at different frequency. The contact angle on the film for water was tested by a JY-PHb contact angle analysis instrument in the room temperature.

Results and discussion

Monomer synthesis

As shown in Scheme 1, the aromatic diamine monomer, 3,3'd i t e r b u t y - 4, 4' - d i a m i n o d i p h e n y 1 - 4" morpholinophenylmethane (TAMPM) was synthesized by the 2-*tert*-butylaniline with 4-morpholinobenzaldenhyde in the presence of catalyst hydrochloric acid. After reaction, the crude product was purified by silica gel chromatography, and then obtained pure diamine monomer TAMPM. The chemical structures of the diamine TAMPM were confirmed by FT-IR, NMR and MS spectrometry.

The FT-IR spectrum of diamine TAMPM showed the characteristic absorptions of the N-H stretching bands of the amino groups at 3500~3300 cm⁻¹, the C-H stretching bands of the alkyl groups at 3000~2800 cm⁻¹, and the characteristic absorption bands appeared at 1120 cm⁻¹ corresponding to C-O-C stretching. The ¹H NMR spectrum of diamine TAMPM was shown in Fig. 1a. The signal at δ 4.56 ppm was special amino groups. The double of aromatic protons appeared in range of δ 6.50–6.91 ppm. The characteristic resonance signals at δ 5.04 ppm, δ 3.68 ppm, δ 3.00 ppm and δ 1.23 ppm corresponded to alkyl -CH-(H⁵), -CH₂- (H³), -CH₂- (H²), and -C(CH₃)₃- (H¹) groups. Obviously, the protons of H¹, H², H³, H⁴ and H⁵ resonated at higher field than other aromatic protons because of the electron-donating property of the amino and alkyl groups. Furthermore, the peaks at δ



Table 1 GPC data and elementalanalyses of the polyimides

Polymer	GPC Data ^a	i		Elemental Analysis (%)				
	$M_{\rm n} \times 10^4$	$M_{ m w} imes 10^4$	$M_{\rm w}/M_{\rm n}$	Formula		С	Ν	
PI-1	4.3	10.0	2.32	$(C_{41}H_{43}N_3O_7)_n$	Calcd	71.39	6.09	
				(689.80) _n	Found	71.16	6.12	
PI-2	4.7	10.0	2.13	(C47H43N3O5)n	Calcd	77.34	5.76	
				(729.86) _n	Found	78.29	5.68	
PI-3	9.3	26.5	2.85	(C47H43N3O6)n	Calcd	75.68	5.63	
				(745.86) _n	Found	76.43	5.58	
PI-4	7.0	38.6	5.51	(C ₄₈ H ₄₃ N ₃ O ₆) _n	Calcd	76.07	5.54	
				(757.87) _n	Found	75.88	5.61	
PI-5	9.4	17.4	1.85	$(C_{50}H_{43}F_6N_3O_5)_n$	Calcd	68.65	4.78	
				(879.88) _n	Found	69.46	4.70	

^a Relative to polystyrene standards, using DMF as the eluent

2.48 ppm and at δ 3.33 ppm were assigned to DMSO and water in DMSO, respectively. The ¹³C NMR spectrum was shown in Fig. 1b, all the carbon atoms resonated in the region of δ 29.73-149.30 ppm, and all the spectrum spectrometry were in good agreement with the propose molecular structure. In addition, MS spectrometry analysis agreed well with the molecular structure. The melting point of monomer was measured by DSC, and the melting peak appeared at 155.2 °C.

Polyimide synthesis

Generally, the methods of preparation of polyimides have onestep and two-step polymerization. As shown in Scheme 2, the polyimides were prepared from diamine monomer TAMPM and various aromatic dianhydrides (PMDA, BPDA, ODPA, BTDA and 6FDA) in the solvent of m-Cresol with the catalyst of isoquinoline under nitrogen protection by one-step procedure. After fully polymerization, the fibrous polyimides were obtained by dumping the polymer solution into an excess of alcohol and re-precipitating using DMF at least twice.

The molecular weight and polydispersity index (M_w/M_n) of the polyimides were characterized by GPC, and the results were summarized in the Table 1. The M_w (weight average molecular weight) and M_w/M_n (polydispersity) were in the



Fig. 2 FTIR spectra of polyimides

range of $10 \times 10^4 \sim 38.6 \times 10^4$ g·mol⁻¹ and $1.85 \sim 5.51$, respectively. The results showed that polyimides have high molecular weight and low polydispersity index, which were used for obtaining flexible and tough films. In addition, the elemental analysis results of polyimides were also listed in Table 1, and the measurement of polymers were in complete agreement with the theoretically calculated values. The FT-IR spectrum of polyimides was also confirmed. As shown in Fig. 2, the characteristic absorptions of imide at 1779 cm^{-1} and 1728 cm⁻¹ attributed to the typical of imide carbonyl asymmetrical and symmetrical stretches. The characteristic absorptions of C-N stretch were around 1374 cm⁻¹, and the characteristic absorption at 1109 cm^{-1} and 732 cm^{-1} were attributed to imide ring deformation. Moreover, the spectra in the range of 2870~3030 cm⁻¹ were confirmed corresponding to alkyl groups. At the same time, the disappearance of N-H characteristic absorption bands identified that diamine monomer was completely transformed into polyimide. The ¹H NMR spectrum of polyimide was in complete agreement with the proposed polymer structure (Fig. 3).

Solubility

The solubility of polyimides was tested in various organic solvent, and the results were listed in Table 2. As is well known, the polyimide usually shows poor solubility in organic solvents due to their stiff chain characteristic and strong interchain interactions, which caused limitation on their applications in extensive fields. Comparing to these insoluble polyimide, the prepared polyimides presented excellent solubility in the high boiling point solvents such as DMF, DMAc, DMSO, NMP and m-Cresol at room temperature. Moreover, these obtained polyimides also exhibited outstanding solubility in the low boiling point solvents such as CHCl₃, CH₂Cl₂, THF, acetone and ethyl acetate. Obviously, the excellent solubility of these polyimides could be partly due to the



introduction of bulky tert-butyl groups, bulky pendant 4morpholinophenyl groups, flexible linkages and noncoplanars in the polymer main, which loosen the packing density of polymer chain, decrease the intermolecule interactions, and increase the fractional free volume. The PI-3 based on ODPA exhibited good solubility behavior in common organic solvents due to the introduction of ether linkage which increased flexibility of polymer. Moreover, the PI-5 could be soluble in acetone, it is due to the introduction of trifuoromenthyl derived from the 6FDA in the polymer backbone. It must be underlined that the outstanding solubility of the polyimides in low boiling point solvent can reduce the processing temperature of the polymer film. The excellent solubility of the polyimides may have the potential application prospects in many high-tech fields, such as coating materials for advanced microelectronics manufacturing, flexible organic solar cells, flexible printed circuit board (FPCP), and flexible displays [23, 29-31].

Lable 2 Soldonity of polynindes	Table 2	Solubility	of polyimides ^{a,}	t
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Thermal properties

The thermal properties of polyimides were evaluated by TGA and DSC in nitrogen atmosphere, and the corresponding results were listed in Table 3. In the Fig. 4. the glass-transition temperatures (T_g) of the polyimides were in the range from 311 °C to 355 °C. Generally, T_{g} is related to the rigidity and conformation of polymer backbone. Moreover, the introduction of bulky tert-butyl group into the ortho-position of the imide nitrogen impeded the rotation of the two aromatic rings around the C-N bond, which improved the stiffness of backbone and glass transition temperature of polyimide [32, 33]. Furthermore, the incorporation of non-coplanar in the main chains also improved the rigidity of polymer. The PI-1 originated from PMDA presented the highest T_{g} due to the characteristic structure of the rigidity of wholly aromatic dianhydride PMDA units. However, PI-3 derived from ODPA showed the lowest $T_{\rm g}$ because of the presence of flexible ether linkages moieties in the polymer backbone.

The curves of TGA of polyimides were listed in Fig. 5. All the polyimides exhibited high thermal stability. The values of thermal onset decomposition temperature (T_d) of polyimides were in the range of 456-468 °C in the Table 3. The 5 % and 10 % weight loss temperature were also listed in Table 3 which based on the original TGA curves. In the nitrogen atmospheres, the $T_{5\%}$ and $T_{10\%}$ weight loss of polyimides were in range of 425-473 °C and 472-494 °C, respectively. Furthermore, char yields of the polyimides at 800 °C was in range from 55 to 67 %. The polyimides showed outstanding thermal stability due to the rigid structure of imides and stiff morpholinophenyl moieties in polymer backbone. The PI-5 based on 6FDA showed comparatively higher thermal stability which can be attributed to strong C-F bond present in $-C(CF_3)_2$ units in the polymer chain.

Polymer	Solvent										
	DMF	DMAc	DMSO	NMP	CHCl ₃	THF	CH ₂ Cl ₂	Acetone	EAc	n-hexane	
PI-1	++	++	++	++	++	++	++	-h	-h	_	
PI-2	++	++	++	++	++	++	++	_	_	_	
PI-3	++	++	++	++	++	++	++	+h	-h	_	
PI-4	++	++	++	++	++	++	++	-h	-h	_	
PI-5	++	++	++	++	++	++	++	++	++	-	

^a Qualitative solubility was tested with 10 mg of a sample in 1 mL of stirred solvent. ++: soluble at room temperature; +h: soluble on heating; --: insoluble even on heating

^b DMF, *N*,*N*-dimethylformamide; DMAc, *N*,*N*-dimethyl acetamide; DMSO, dimethyl sulfoxide; NMP, *N*-methyl-2-pyrrolidone; CHCl₃, chloroform; THF, tetrahydrofuran; CH₂Cl₂, dichloromethane; EAc, ethyl acetate

Table 3 Thermal and opticalproperties of polyimides

Polymer	$T_{\rm g}$	$T_{\rm d}$	$T_{5\%}$	$T_{10\%}$	Char Yield(%) ^d	$\lambda_{cutoff}(nm)$	Transparency (%) ^e
	(\mathbf{C})	(\mathbf{C})	(0)	(0)			
PI-1	355	457	433	475	55	317	80
PI-2	330	468	456	488	59	344	84
PI-3	311	465	461	487	67	329	85
PI-4	315	456	425	472	67	326	78
PI-5	312	468	473	494	63	287	86
Kapton ^f	—	—	—	—	_	400	69

 a Midpoint temperature of baseline shift on the second DSC heating trace (rate 20 °C/min) of the sample after quenching from 400 °C in N_2

^b $T_{\rm d}$: onset decomposition temperature, recorded via TGA at a heating rate of 10 °C/min

° 5% and 10 % weight loss Temperature also recorded via TGA at a heating rate of 10 °C/min

^d Char Yield (wt%) at 800 °C in nitrogen. ^e Average transmittance in the visible region (400–700 nm). ^f According to the literature [34]

Optical properties

The UV-vis spectra of the polyimide films were performed with the thickness of ca. 10-15 µm, and results were listed in Table 3. As shown in Fig. 6, the polyimide exhibited lower cutoff wavelength and higher optical transparency. The cutoff wavelength of polyimide films was in the range of 287-344 nm. The transparency of polymer films in the visible region was investigated by averaging the transmittances in the range from 400 to 700 nm. The results showed that the average transmittance of films were above 78 % in the wavelength range of 400–700 nm. According to the literature [34], the obtained polymer films presented better optical transparency than that of commercial Kapton film with similar thickness. Moreover, as shown in Fig. 7, compared with a photograph of the commercial Kapton film with the thickness of ca. 45 µm in visible light, it was obviously that the color of polyimide films is more shallow and transparency than that of Kapton film. The polyimide films presented outstanding optical properties due to the introduction of bulky tert-butyl group, bulky pendant 4-morpholinophenyl group, flexible linkage and non-coplanar moieties in the polymer backbone, which can loosen the density of polymer chain packing and decrease the intermolecular interaction, and then reduce the



Fig. 4 DSC curves of polyimides

formation of intermolecular charge-transfer complex (CTC) between the alternating electron-donar (diamine) and electron-acceptor (dianhydride) moieties [35]. Obviously, PI-5 presented lowest cutoff wavelength and the highest optical transpatency which attributed to the flexible linkage of fluorinated bulky $-C(CF_3)_2$, which might reduce the intermolecular cohesive force because of the lower polarizability of the C-F bond. Furthermore, PI-3 exhibited excellent optical transparency due to the presence of the flexible ether linkages in the polymer chain, which could weaken the formation of the interand intro-molecular CTC effectively. Unexpectedly, PI-2 originated from BPDA also showed lighter color in the visible light, it may be the result of the twist of biphenyl moieties in the polymer conjugation effect and inhibit the formation of CTC.

Dielectric properties

It is well known that polymers have been widely used in dielectric material fields due to its lower dielectric constant, easy preparation and excellent properties. In particular, polyimides as dielectric materials have been attracted much more attention in microelectronic fields in recent years. It is attributed to its excellent comprehensive properties, such as heat resistance, ultraviolet radiation resistant, weathering



Fig. 5 TGA curves of polyimides



Fig. 6 UV-vis spectra of Polyimide films

resistance, high modulus and low dielectric constant as compared with other polymers.

The dielectric constants of polyimide films were determined by the parallel plate capacitor method using a dielectric analyzer (Agilent 4294A) on thin film, and all of the film samples were tested under the same conditions. The results were summarized in Table 4. The obtained polyimide films with a thickness of 50-60 µm were used in this study. The dielectric constants of all the polyimides were in the range of 2.97-3.33 at 1 kHz, 2.92-3.28 at 10 kHz and 2.85-3.16 at 1 MHz, respectively, which were lower than those of the commercial polyimide such as Kapton (3.48 at 1 MHz). The lower dielectric constants may be attributed to the introduction of the bulky side group (tert-butyl) and the pendant group (morpholinophenyl), which loosened polymer packing density and increased free volume. Furthermore, PI-5 originated from diamine TAMPM and dianhydride 6FDA exhibited lowest dielectric constant, which may be due to the result of the strong eletronegativity of the fluorine atoms, which resulted in very low polarizability of the C-F bonds and then reduced the dielectric constant.

Hydrophobic properties

The contact angle of polyimides PI 1–5 and Kapton for water (θ_w) were listed in Table 4. Figure 8 depicted the profiles of droplet on the film surfaces. It is well known that the higher





Table 4 Dielectric properties and contact angle of polyimide films

Polymer	Film thickness (µm)	Dielectr	Contact		
		1 kHz	10 kHz	1 MHz	angle ()
PI-1	50	3.22	3.15	3.05	92.1
PI-2	55	3.26	3.19	3.10	93.2
PI-3	52	3.33	3.28	3.16	85.1
PI-4	56	3.18	3.12	3.03	91.3
PI-5	60	2.97	2.92	2.85	94.2

contact angle polymer has, the hydrophobic property of the polymer will become better. Among all the polyimides, the contact angles of obtained polyimides (85.1–94.2°) were higher than that of commercial Kapton (81.6°) due to the incorporation of the hydrophobic groups, such as *tert*-butyl and morpholinophenyl moieties in the polymer main, and the PI-5 derived from 6FDA presented the best hydrophobic property. It is because of the introduction of 6FDA in the backbone, which reduced the surface energy of polymer, and then presented excellent hydrophobic property. The contact angle of PI-3 was 85.1°, and it was a little lower than that of other obtained polyimides. It may be due to the ether linkage of PI-3 originated from ODPA form hydrogen bond with water, and then lead to relatively poorly hydrophobic property.

Conclusions

A novel aromatic diamine TAMPM containing *tert*-butyl and morpholinyl units was synthesized by reasonable molecular design, and then a series of new polyimides were synthesized by polycondensation via the conventional one-step method. All of the polyimide presented excellent solubility, good thermal stability, high optical transparency, low dielectric constants and outstanding hydrophobic properties. These polymers could be considered as potential applications for high performance polymer materials, flexible solar cells, flexible displays, flexible printed circuit board, microelectronic devices, and so on.



Fig. 8 The contact angle of Kapton and Polyimide films

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